

N-CHANNEL 60V - 0.07Ω - 4A SOT-223 STripFET™ II POWER MOSFET

TYPE	V _{DSS}	R _{DS(on)}	ID
STN3NF06L	60 V	< 0.1 Ω	4 A

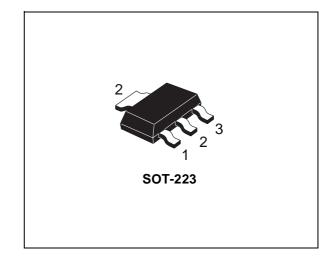
- TYPICAL $R_{DS}(on) = 0.07 \Omega$
- EXCEPTIONAL dv/dt CAPABILITY
- AVALANCHE RUGGED TECHNOLOGY
- 100% AVALANCHE TESTED
- LOW THRESHOLD DRIVE

DESCRIPTION

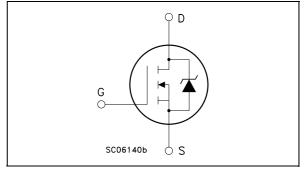
This Power MOSFET is the latest development of STMicroelectronis unique "Single Feature Size™" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

APPLICATIONS

- DC-DC & DC-AC COVERTERS
- DC MOTOR CONTROL (DISK DRIVERS, etc.)
- SYNCHRONOUS RECTIFICATION



INTERNAL SCHEMATIC DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source Voltage ($V_{GS} = 0$)	60	V
Vdgr	Drain-gate Voltage (R_{GS} = 20 k Ω)	60	V
V_{GS}	Gate- source Voltage	± 16	V
I _D (●)	Drain Current (continuous) at $T_C = 25^{\circ}C$	4	А
ID	Drain Current (continuous) at $T_C = 100^{\circ}C$	2.9	A
I _{DM} (●●)	Drain Current (pulsed)	16	A
P _{tot}	Total Dissipation at $T_C = 25^{\circ}C$	3.3	W
	Derating Factor	0.026	W/°C
dv/dt (1)	Peak Diode Recovery voltage slope	10	V/ns
E _{AS} (2)	Single Pulse Avalanche Energy	200	mJ
T _{stg}	Storage Temperature	-55 to 150	°C
Tj	Operating Junction Temperature	-35 10 150	C
) Pulse width) Current limite 	limited by safe operating area. ed by the package	(1) $I_{SD} \le 3A$, di/dt $\le 150A/\mu s$, $V_{DD} \le V_{(BR)DSS}$, $T_j \le$ (2) Starting $T_j = 25 \text{ °C}$, $I_D = 4A$, $V_{DD} = 30V$	T _{JMAX}

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THERMAL DATA

Rthj-pcb Rthj-pcb T1Thermal Resistance Junction-PCB (*) Thermal Resistance Junction-PCB (**) Maximum Lead Temperature For Soldering Purpose (for 10 sec. 1.6 mm from case)	Max	38	°C/W
	Max	100	°C/W
	Typ	260	°C

 $\binom{*}{*}$ When Mounted on FR-4 board with 1 inch² pad, 2 oz of Cu and t \leq 10 sec $\binom{**}{*}$ When Mounted on minimum footprint

ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0$	60			V
I _{DSS}	Zero Gate Voltage Drain Current (V _{GS} = 0)	V_{DS} = Max Rating V_{DS} = Max Rating T _C = 125°C			1 10	μΑ μΑ
I _{GSS}	Gate-body Leakage Current (V _{DS} = 0)	V _{GS} = ± 16 V			±100	nA

ON (*)

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$	I _D = 250 μA	1		2.8	V
R _{DS(on)}	Static Drain-source On Resistance	V _{GS} = 10 V V _{GS} = 5 V	I _D = 1.5 A I _D = 1.5 A		0.07 0.085	0.10 0.12	Ω Ω

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
g _{fs} (*)	Forward Transconductance	V _{DS} = 15 V I _D = 1.5 A		3		S
C _{iss} C _{oss} C _{rss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	V _{DS} = 25V, f = 1 MHz, V _{GS} = 0		340 63 30		pF pF pF

ELECTRICAL CHARACTERISTICS (continued)

SWITCHING ON

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r	Turn-on Delay Time Rise Time			9 25		ns ns
Q _g Q _{gs} Q _{gd}	Total Gate Charge Gate-Source Charge Gate-Drain Charge	$V_{DD} = 48V$ $I_D = 3A$ $V_{GS} = 5V$		7 1.5 2.8	9	nC nC nC

SWITCHING OFF

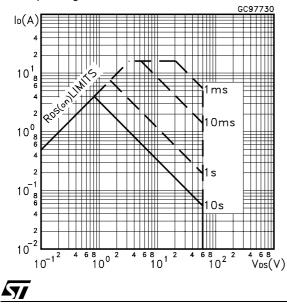
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{d(off)} t _f	Turn-off Delay Time Fall Time	$ \begin{array}{ll} V_{DD}=30 \ V & I_{D}=1.5 \ A \\ R_{G}=4.7 \Omega, & V_{GS}=5 \ V \\ (\text{Resistive Load, Figure 3}) \end{array} $		20 10		ns ns

SOURCE DRAIN DIODE

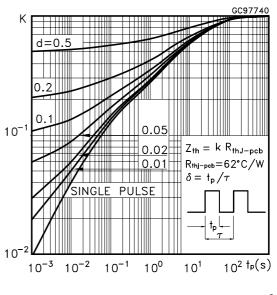
Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
I _{SD} I _{SDM} (●)	Source-drain Current Source-drain Current (pulsed)					4 16	A A
V _{SD} (*)	Forward On Voltage	I _{SD} = 4 A	$V_{GS} = 0$			1.5	V
t _{rr} Q _{rr} I _{RRM}	Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current	$I_{SD} = 4 A$ $V_{DD} = 25 V$ (see test circu	di/dt = 100A/µs T _j = 150°C it, Figure 5)		50 88 3.5		ns nC A

(*)Pulsed: Pulse duration = 300 µs, duty cycle 1.5 %.
(•)Pulse width limited by safe operating area.

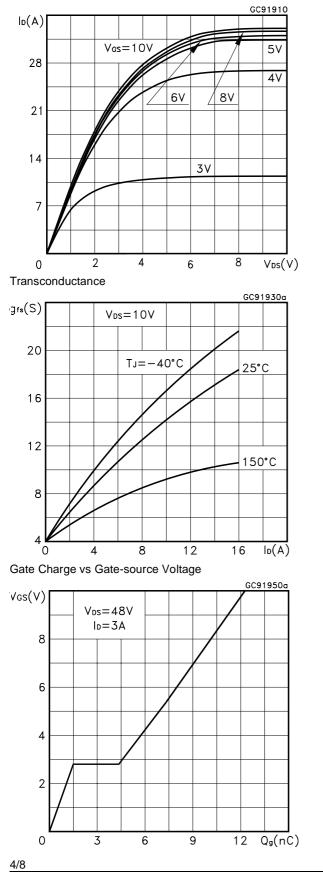
Safe Operating Area

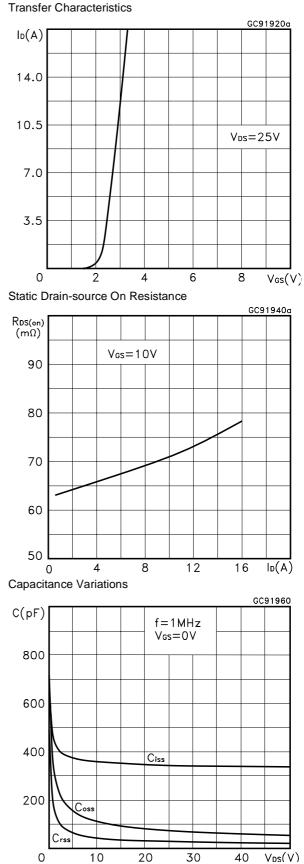


Thermal Impedance

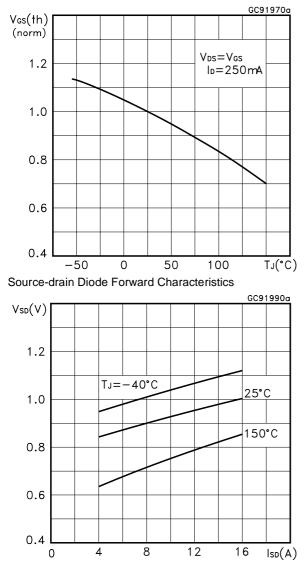


Output Characteristics



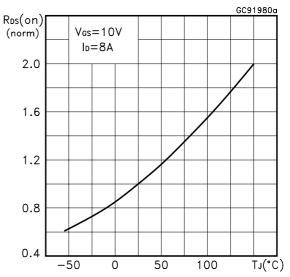


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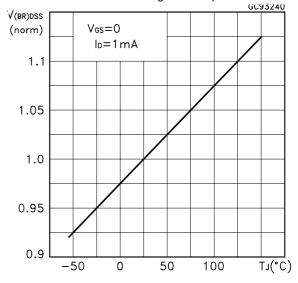


Normalized Gate Threshold Voltage vs Temperature

Normalized on Resistance vs Temperature



Normalized Breakdown Voltage vs Temperature.



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Fig. 1: Unclamped Inductive Load Test Circuit

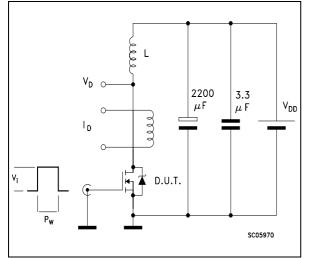
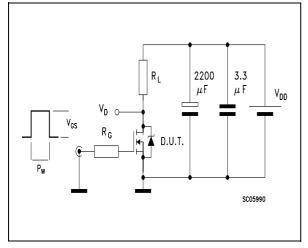
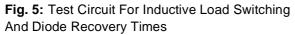


Fig. 3: Switching Times Test Circuits For Resistive Load





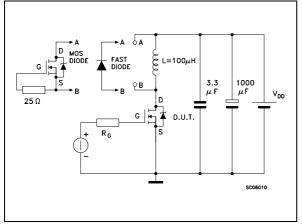


Fig. 2: Unclamped Inductive Waveform

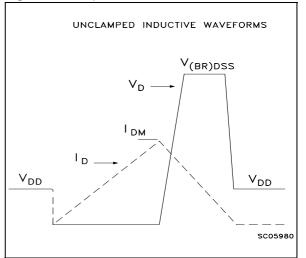
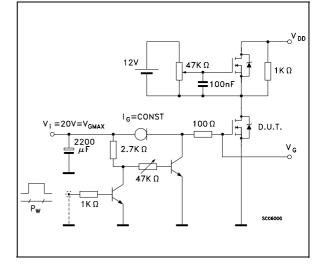


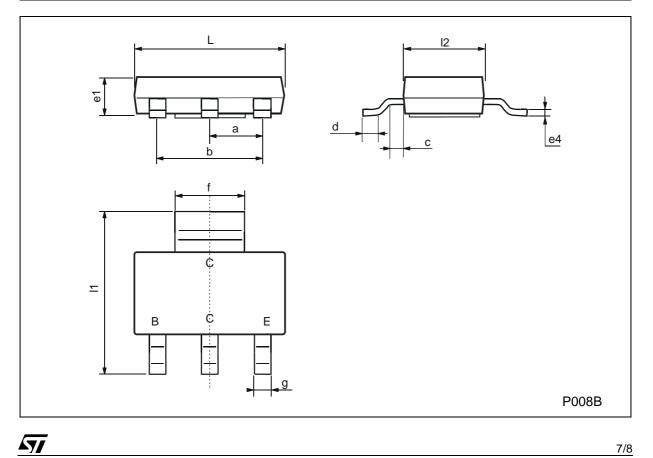
Fig. 4: Gate Charge test Circuit



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DIM.		mm			mils			
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.		
а	2.27	2.3	2.33	89.4	90.6	91.7		
b	4.57	4.6	4.63	179.9	181.1	182.3		
С	0.2	0.4	0.6	7.9	15.7	23.6		
d	0.63	0.65	0.67	24.8	25.6	26.4		
e1	1.5	1.6	1.7	59.1	63	66.9		
e4			0.32			12.6		
f	2.9	3	3.1	114.2	118.1	122.1		
g	0.67	0.7	0.73	26.4	27.6	28.7		
11	6.7	7	7.3	263.8	275.6	287.4		
12	3.5	3.5	3.7	137.8	137.8	145.7		
L	6.3	6.5	6.7	248	255.9	263.8		

SOT-223 MECHANICAL DATA



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